



DUAL N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C	
100V	17.4mΩ @ V _{GS} = 10V	54.7A	
100 V	$30.3 \text{m}\Omega$ @ $V_{GS} = 4.5 \text{V}$	41.4A	

Description and Applications

This new generation MOSFET features low on-resistance and fast switching, making it ideal for high efficiency power management applications.

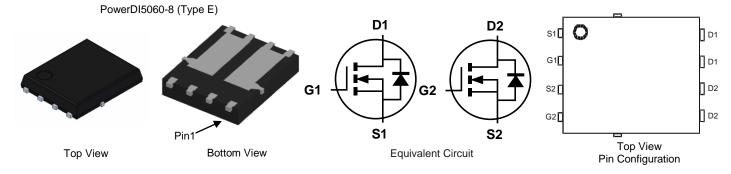
- Synchronous Rectifier
- **DC-DC Converters**
- Primary Side Switching

Features and Benefits

- 100% Unclamped Inductive Switching—Ensures More Reliable and Robust End Application
- High-Conversion Efficiency
- Low R_{DS(ON)}—Minimizes On State Losses
- Low-Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC- Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208@3
- Weight: 0.097 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMT10H017LPD-13	PowerDI5060-8 (Type E)	2500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3).compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



) :: = Manufacturer's Marking 10H017LD = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 19 = 2019)WW = Week (01 to 53)

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	100	V	
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current, $V_{GS} = 10V$ (Note 6) $T_C = +25^{\circ}C$ $T_C = +70^{\circ}C$		I _D	54.7 43.7	А
Maximum Body Diode Forward Current (Note 6)	Is	60	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	60	А	
Avalanche Current, L = 3mH (Note 8)	I _{AS}	10	А	
Avalanche Energy, L = 3mH (Note 8)	Eas	150	mJ	
Avalanche Current, L = 1mH	I _{AS}	10	A	
Avalanche Energy, L = 1mH	E _{AS}	50	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation	T _A = +25°C	P _D	2.2	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{OJA}	56	°C/W	
Total Power Dissipation	$T_C = +25^{\circ}C$	P_{D}	78	W
Thermal Resistance, Junction to Case (Note 6)		R _{OJC}	1.6	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

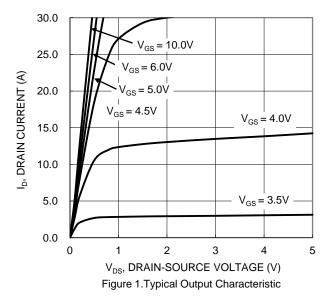
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_		1	μA	V _{DS} = 80V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_		±100	nA	$V_{GS} = \pm 16V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	•			•			
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	13.7	17.4	mΩ	V _{GS} = 10V, I _D = 17A	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	23.5	30.3	11122	V _{GS} = 4.5V, I _D = 10A	
Diode Forward Voltage	V _{SD}		0.8	1.3	V	V _{GS} = 0V, I _S = 17A	
DYNAMIC CHARACTERISTICS (Note 8)				I.			
Input Capacitance	C _{iss}	_	1986	_			
Output Capacitance	Coss	_	333	_	pF	$V_{DS} = 50V, V_{GS} = 0V,$ f = 1MHz	
Reverse Transfer Capacitance	Crss	_	20	_		- 1101112	
Gate Resistance	R_{G}	_	1.17	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	14.4	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	28.6	_	nC	50/ 1- 204	
Gate-Source Charge	Qgs	_	5.2	_	IIC	$V_{DS} = 50V, I_{D} = 20A$	
Gate-Drain Charge	Q_{gd}	_	8.2	_			
Turn-On Delay Time	t _{D(ON)}	_	9.8	_			
Turn-On Rise Time	t _R	_	16.3	_	ns	$V_{DD} = 50V, V_{GS} = 10V,$	
Turn-Off Delay Time	t _{D(OFF)}		32.6	_	115	$R_G = 11\Omega, I_D = 20A$	
Turn-Off Fall Time	t _F		21.6	_			
Body Diode Reverse Recovery Time	t _{RR}	_	40.6	_	ns	I _F = 17A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q_{RR}	_	58.1	_	nC	I _F = 17A, di/dt = 100A/μs	

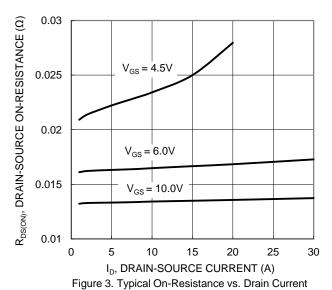
Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.6. Thermal resistance from junction to solder point (on the exposed drain pin).7. Short duration pulse test used to minimize self-heating effect.

- 8. Guaranteed by design. Not subject to product testing.







0.032 $R_{DS(ON)}$, DRAIN-SOURCE ON-RESISTANCE (Ω) 0.03 V_{GS}=10V T_J= 150℃ 0.028 0.026 T_.= 125℃ 0.024 0.022 T_J= 85℃ 0.02 0.018 0.016 T_J= 25°C 0.014 0.012 T_J = -55 $^{\circ}$ C 0.01 0.008 0.006 0.004

and Gate Voltage

I_D, DRAIN CURRENT (A)
Figure 5. Typical On-Resistance vs. Drain Current and Temperature

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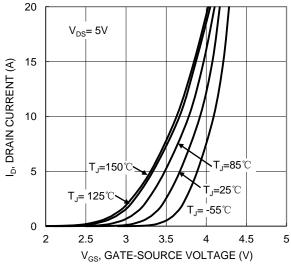


Figure 2. Typical Transfer Characteristic

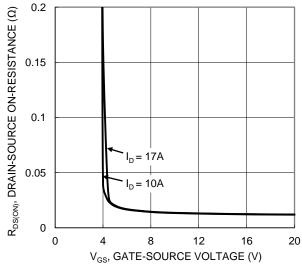


Figure 4. Typical Transfer Characteristic

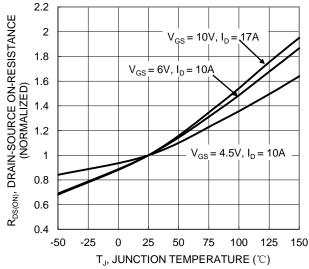


Figure 6. On-Resistance Variation with Temperature

30



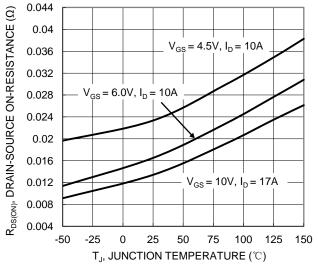


Figure 7. On-Resistance Variation with Temperature

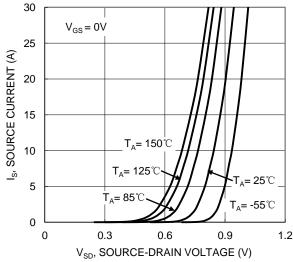
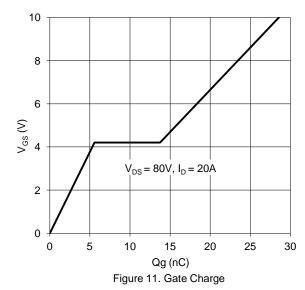
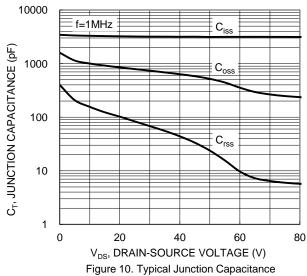


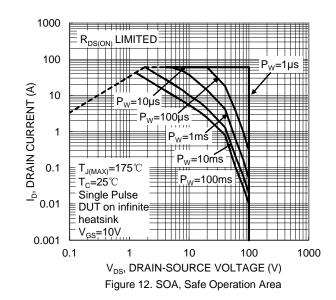
Figure 9. Diode Forward Voltage vs. Current



3 $V_{GS(TH)},$ GATE THRESHOLD VOLTAGE (V) 2.8 2.6 2.4 $I_D = 1mA$ 2.2 2 $I_{D} = 250 \mu A$ 1.8 1.6 1.4 1.2 -25 0 25 100 125 -50 50 75 150 T., JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. JunctionTemperature







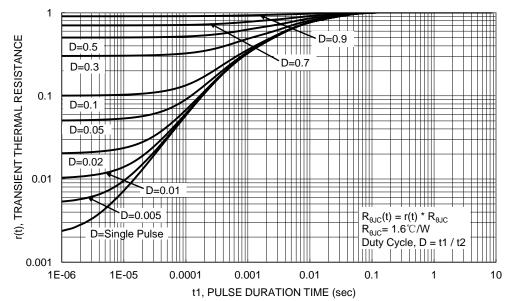


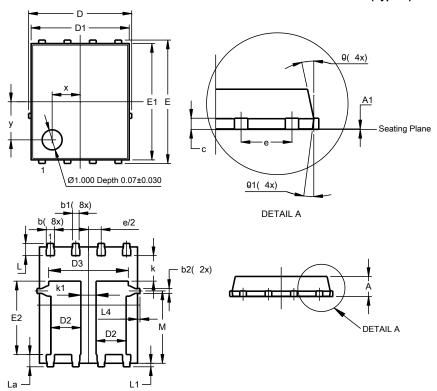
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type E)

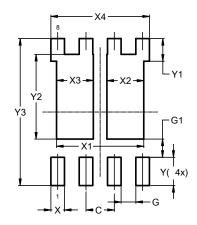


PowerDI5060-8								
(Type E)								
Dim	Min	Max	Тур					
Α	0.90	1.10	1.00					
A1	0	0.05	0.02					
b	0.33	0.51	0.41					
b1	0.300	0.366	0.333					
b2	0.20	0.35	0.25					
C	0.23	0.33	0.277					
D	5	.15 BS0)					
D1	4.85	4.95	4.90					
D2	1.40	1.60	1.50					
D3	-	-	3.98					
Е	6	.15 BS0	2					
E1	5.75	5.85	5.80					
E2	3.56	3.76	3.66					
е	1	.27BSC						
k	-	-	1.27					
k1	0.56	-	-					
L	0.51	0.71	0.61					
La	0.51	0.71	0.61					
L1	0.05	0.20	0.175					
L4	-	-	0.125					
M	3.50	3.71	3.605					
Х	-	-	1.400					
у	-	-	1.900					
θ	10° 12° 11°							
θ1	6° 8° 7°							
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type E)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	3.910		
X2	1.650		
Х3	1.650		
X4	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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